

DGG OR DL PACKAGE (TOP VIEW)

PRE

S

S

SEL0 2

SCES022G-JULY 1995-REVISED OCTOBER 2004

56 CLK

55 SELEN

FEATURES
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•	Member of the Texas Instruments Widebus™
	Family

- UBE<sup>™</sup> (Universal Bus Exchanger) Allows Synchronous Data Exchange
- Operates From 1.65 V to 3.6 V
- Max t<sub>pd</sub> of 5.1 ns at 3.3 V
- ±24-mA Output Drive at 3.3 V
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- **ESD Performance Tested Per JESD 22** - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

### DESCRIPTION/ORDERING INFORMATION

This 9-bit, 4-port universal bus exchanger is designed for 1.65-V to 3.6-V V<sub>CC</sub> operation.

The SN74ALVCH16409 allows synchronous data exchange between four different buses. Data flow is controlled by the select (SEL0-SEL4) inputs. A data-flow state is stored on the rising edge of the clock (CLK) input if the select-enable (SELEN) input is low. Once a data-flow state has been established, data is stored in the flip-flop on the rising edge of CLK if SELEN is high.

The data-flow control logic is designed to allow glitch-free data transmission.

When preset (PRE) transitions high, the outputs are disabled immediately, without waiting for a clock pulse. To leave the high-impedance state, both PRE and SELEN must be low, and a clock pulse must be applied.

	_	
1A1	3	54 🛛 1B1
GND	4	53 🛛 GND
1A2	5	52 ] 1B2
1A3	6	51 ] 1B3
V <sub>CC</sub>	7	50 🛛 V <sub>CC</sub>
1A4	8	49 🛛 1B4
1A5	9	48 🛛 1B5
1A6	10	47 🛛 1B6
GND	11	46 🛛 GND
1A7	12	45 🛛 1B7
1A8	13	44 🛛 1B8
1A9	14	43 🛛 1B9
2A1	15	42 2B1
2A2	16	41 🛛 2B2
2A3	17	40 🛛 2B3
GND	18	39 🛛 GND
2A4	19	38 🛛 2B4
2A5	20	37 🛛 2B5
2A6	21	36 🛛 2B6
V <sub>CC</sub>	22	35 ] V <sub>CC</sub>
2A7	23	34 🛛 2B7
2A8	24	33 🛛 2B8
GND	25	32 🛛 GND
2A9	26	31 🛛 2B9
SEL1	27	30 ] SEL4
SEL2	28	29 ] SEL3

To ensure the high-impedance state during power up or power down, PRE should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

#### **ORDERING INFORMATION**

T <sub>A</sub>	PACK	AGE <sup>(1)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SSOP - DL	Tube	SN74ALVCH16409DL	
-40°C to 85°C	550P - DL	Tape and reel	SN74ALVCH16409DLR	ALVCH16409
	TSSOP - DGG	Tape and reel	SN74ALVCH16409DGGR	ALVCH16409

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at (1) www.ti.com/sc/package.



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### **FUNCTION TABLES**

IN	PUTS	OUTPUT
CLK	SEND PORT	RECEIVE PORT
Х	Х	B <sub>0</sub> <sup>(1)</sup>
Х	L	L
Х	Н	Н
$\uparrow$	L	L
$\uparrow$	Н	Н
н	Х	B <sub>0</sub> <sup>(1)</sup>
L	Х	B <sub>0</sub> <sup>(1)</sup> B <sub>0</sub> <sup>(1)</sup>

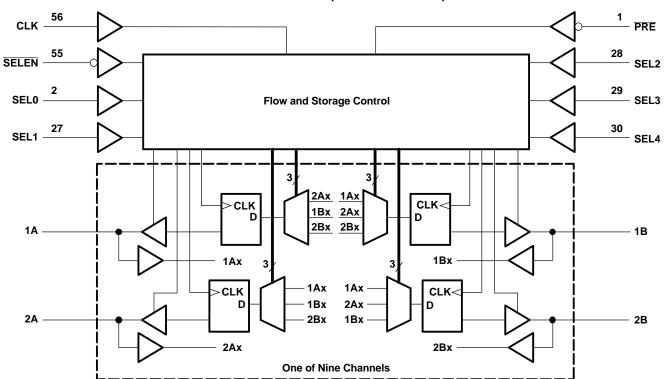
(1) Output level before the indicated steady-state input conditions were established

			INP	UTS		NIKOL		
PRE	SELEN	CLK	SEL0	SEL1	SEL2	SEL3	SEL4	DATA FLOW
Н	Х	Х	Х	Х	Х	Х	Х	All outputs disabled
L	Н	$\uparrow$	х	Х	Х	Х	Х	No change
L	L	$\uparrow$	0	0	0	0	0	None, all I/Os off
L	L	$\uparrow$	0	0	0	0	1	Not used
L	L	$\uparrow$	0	0	0	1	0	Not used
L	L	$\uparrow$	0	0	0	1	1	Not used
L	L	$\uparrow$	0	0	1	0	0	Not used
L	L	$\uparrow$	0	0	1	0	1	Not used
L	L	$\uparrow$	0	0	1	1	0	Not used
L	L	$\uparrow$	0	0	1	1	1	Not used
L	L	$\uparrow$	0	1	0	0	0	2A to 1A and 1B to 2B
L	L	$\uparrow$	0	1	0	0	1	2A to 1A
L	L	$\uparrow$	0	1	0	1	0	2B to 1B
L	L	$\uparrow$	0	1	0	1	1	2A to 1A and 2B to 1B
L	L	$\uparrow$	0	1	1	0	0	1A to 2A and 1B to 2B
L	L	$\uparrow$	0	1	1	0	1	1A to 2A
L	L	$\uparrow$	0	1	1	1	0	1B to 2B
L	L	$\uparrow$	0	1	1	1	1	1A to 2A and 2B to 1B
L	L	$\uparrow$	1	0	0	0	0	1A to 1B and 2B to 2A
L	L	$\uparrow$	1	0	0	0	1	1A to 1B
L	L	$\uparrow$	1	0	0	1	0	2A to 2B
L	L	$\uparrow$	1	0	0	1	1	1A to 1B and 2A to 2B
L	L	$\uparrow$	1	0	1	0	0	1B to 1A and 2A to 2B
L	L	$\uparrow$	1	0	1	0	1	1B to 1A
L	L	$\uparrow$	1	0	1	1	0	2B to 2A
L	L	$\uparrow$	1	0	1	1	1	1B to 1A and 2B to 2A
L	L	$\uparrow$	1	1	0	0	0	2B to 1A and 2A to 1B
L	L	$\uparrow$	1	1	0	0	1	1B to 2A
L	L	$\uparrow$	1	1	0	1	0	2B to 1A
L	L	$\uparrow$	1	1	0	1	1	2B to 1A and 1B to 2A
L	L	$\uparrow$	1	1	1	0	0	1A to 2B and 1B to 2A
L	L	$\uparrow$	1	1	1	0	1	1A to 2B
L	L	$\uparrow$	1	1	1	1	0	2A to 1B
L	L	$\uparrow$	1	1	1	1	1	1A to 2B and 2A to 1B

#### DATA-FLOW CONTROL



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### **ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range		-0.5	4.6	V
		Except I/O ports <sup>(2)</sup>	-0.5	4.6	
VI	Input voltage range	I/O ports <sup>(2)(3)</sup>	-0.5	V <sub>CC</sub> + 0.5	V
Vo	Output voltage range <sup>(2)(3)</sup>		-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
I <sub>O</sub>	Continuous output current			±50	mA
	Continuous current through each $V_{CC}$ of	or GND		±100	mA
0	Decline the tracel introduction $(4)$	DGG package		64	0000
$\theta_{JA}$	Package thermal impedance <sup>(4)</sup>	DL package		56	°C/W
T <sub>stg</sub>	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) This value is limited to 4.6 V maximum.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

### **RECOMMENDED OPERATING CONDITIONS**<sup>(1)</sup>

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		1.65	3.6	V
		V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65  imes V_{CC}$		
V <sub>IH</sub>	High-level input voltage	$V_{CC}$ = 2.3 V to 2.7 V	1.7		V
		$V_{CC}$ = 2.7 V to 3.6 V	2		
		V <sub>CC</sub> = 1.65 V to 1.95 V		$0.35 \times V_{CC}$	
V <sub>IL</sub>	Low-level input voltage	$V_{CC}$ = 2.3 V to 2.7 V		0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8	
VI	Input voltage		0	V <sub>CC</sub>	V
Vo	Output voltage		0	V <sub>CC</sub>	V
		V <sub>CC</sub> = 1.65 V		-4	
	Lich lovel output ourrest	$V_{CC} = 2.3 V$		-12	~ ^
I <sub>OH</sub>	High-level output current	$V_{CC} = 2.7 V$		-12	mA
		$V_{CC} = 3 V$		-24	
		V <sub>CC</sub> = 1.65 V		4	
	Low lovel output ourrent	$V_{CC} = 2.3 V$		12	mA
I <sub>OL</sub>	Low-level output current	$V_{CC} = 2.7 V$		12	ША
		$V_{CC} = 3 V$		24	
Δt/Δv	Input transition rise or fall rate			10	ns/V
T <sub>A</sub>	Operating free-air temperature		-40	85	°C

 All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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#### **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

PARA	METER	TEST CONDITIONS	V <sub>cc</sub>	MIN	TYP <sup>(1)</sup>	MAX	UNIT	
		I <sub>OH</sub> = -100 μA	1.65 V to 3.6 V	V <sub>CC</sub> - 0.2				
		I <sub>OH</sub> = -4 mA	1.65 V	1.2				
		I <sub>OH</sub> = -6 mA	2.3 V	2				
V <sub>OH</sub>			2.3 V	1.7			V	
		I <sub>OH</sub> = -12 mA	2.7 V	2.2				
			3 V	2.4				
		I <sub>OH</sub> = -24 mA	3 V	2				
		I <sub>OL</sub> = 100 μA	1.65 V to 3.6 V			0.2		
V <sub>OL</sub>		I <sub>OL</sub> = 4 mA	1.65 V			0.45		
		I <sub>OL</sub> = 6 mA	2.3 V			0.4	V	
		40.54	2.3 V			0.7	V	
		I <sub>OL</sub> = 12 mA	2.7 V			0.4		
		I <sub>OL</sub> = 24 mA	3 V	0.55				
l <sub>l</sub>		$V_{I} = V_{CC} \text{ or } GND$	3.6 V			±5	μΑ	
		V <sub>I</sub> = 0.58 V	1.65 V	25				
		V <sub>I</sub> = 1.07 V	1.65 V	-25				
		V <sub>1</sub> = 0.7 V	2.3 V	45				
I <sub>I(hold)</sub>		V <sub>I</sub> = 1.7 V	2.3 V	-45			μA	
. ,		V <sub>1</sub> = 0.8 V	3 V	75				
		V <sub>1</sub> = 2 V	3 V	-75				
		$V_{I} = 0 \text{ to } 3.6 V^{(2)}$	3.6 V			±500		
I <sub>OZ</sub> <sup>(3)</sup>		$V_{O} = V_{CC} \text{ or } GND$	3.6 V			±10	μA	
I <sub>CC</sub>		$V_{I} = V_{CC}$ or GND, $I_{O} = 0$	3.6 V			40	μA	
Δl <sub>CC</sub>		One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			750	μA	
	ontrol inputs	$V_{I} = V_{CC}$ or GND	3.3 V		4		pF	
	or B ports	$V_{O} = V_{CC}$ or GND	3.3 V		8		pF	

(1) All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . (2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

(3) For I/O ports, the parameter  $I_{\mbox{\scriptsize OZ}}$  includes the input leakage current.

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### TIMING REQUIREMENTS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

			V <sub>CC</sub> =	V <sub>CC</sub> = 1.8 V		V <sub>CC</sub> = 1.8 V		V <sub>CC</sub> = 1.8 V		$V_{CC}$ = 2.5 V ± 0.2 V		2.7 V	V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX					
f <sub>clock</sub>	Clock frequency			(1)		120		120		120	MHz				
tw	Pulse duration, CLK h	igh or low	(1)		4.2		4.2		3		ns				
	<b>0</b>	A or B before CLK1	(1)		1.9		1.9		1.4						
		SEL before CLK↑	(1)		5.1		4.2		3.5						
t <sub>su</sub>	Setup time	SELEN before CLK1	(1)		2.5		2.5		1.8		ns				
		PRE before CLK↑	(1)		1		1		0.7						
		A or B after CLK↑	(1)		0.8		0.8		1						
t <sub>h</sub>	Hold time	SEL after CLK↑	(1)		0		0		0		ns				
		SELEN after CLK <sup>↑</sup>	(1)		0.5		0.5		0.8						

(1) This information was not available at the time of publication.

### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> =	1.8 V	V <sub>CC</sub> = ± 0.	2.5 V 2 V	V <sub>CC</sub> =	2.7 V	V <sub>CC</sub> = ± 0.	3.3 V 3 V	UNIT
	(INPOT)	(001901)	MIN	ТҮР	MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>			(1)		120		120		120		MHz
t <sub>pd</sub>	CLK	A or B		(1)	1.5	6		5.7	1.5	5.1	ns
t <sub>en</sub>	CLK	A or B		(1)	2.4	6.9		6.3	2	5.7	ns
	CLK			(1)	2.3	7.1		6	2	5.7	2
t <sub>dis</sub>	PRE	A or B		(1)	2.8	7.5		6.5	2.5	6.1	ns

(1) This information was not available at the time of publication.

### **OPERATING CHARACTERISTICS**

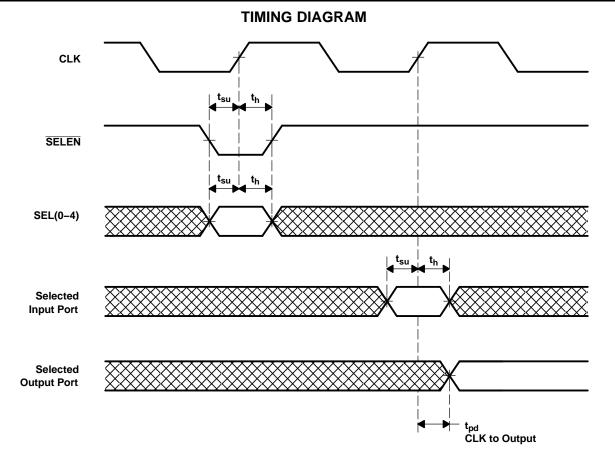
 $T_A = 25^{\circ}C$ 

	PARAMETE	R	TEST CONDITIONS	V <sub>CC</sub> = 1.8 V TYP	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V TYP	UNIT
	Power dissipation	All outputs enabled		(1)	60	60	
C <sub>pd</sub>	capacitance per exchanger	All outputs disabled	$C_{L} = 50 \text{ pF}, \text{ f} = 10 \text{ MHz}$	(1)	60	60	pF

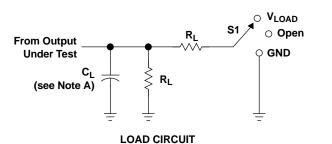
(1) This information was not available at the time of publication.



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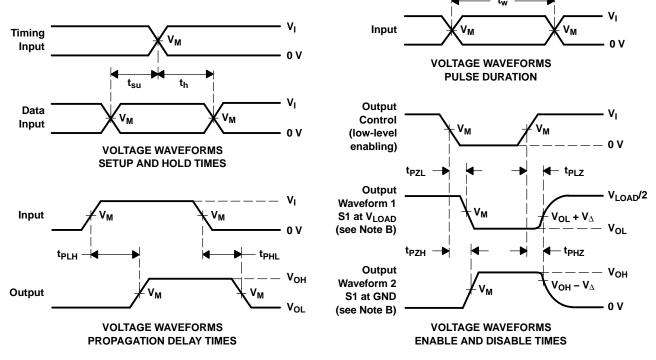
TEST	S1
t <sub>pd</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

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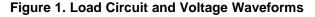
Γ	v <sub>cc</sub>	INPUT		V	V	<b>^</b>	Р	N
		VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	V <sub>LOAD</sub>	CL	RL	$V_{\Delta}$
ſ	1.8 V $\pm$ 0.15 V	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	30 pF	<b>1 k</b> Ω	0.15 V
	2.5 V $\pm$ 0.2 V	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	30 pF	<b>500</b> Ω	0.15 V
	2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	<b>500</b> Ω	0.3 V
	3.3 V $\pm$ 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	<b>500</b> Ω	0.3 V

PARAMETER MEASUREMENT INFORMATION



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

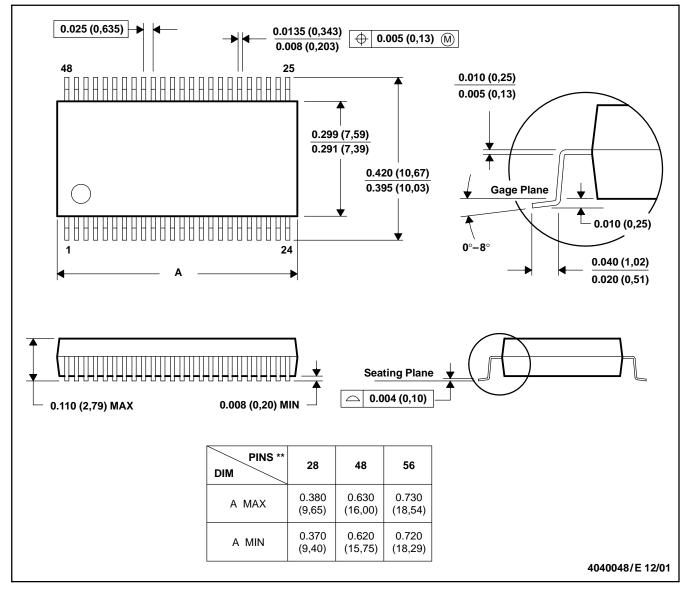


# **MECHANICAL DATA**

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

#### PLASTIC SMALL-OUTLINE PACKAGE

DL (R-PDSO-G\*\*) 48 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118



# **MECHANICAL DATA**

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

#### DGG (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

**48 PINS SHOWN** 



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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